

T-41-85

**ABORN ELECTRONICS, INC.**

Optically-Coupled Darlington Isolator

Optoelectronic Products

FCD860/C/D FCD865/C/D

General Description

The FCD860, FCD865 series of optoisolators have a silicon npn Planar Darlington phototransistor coupled to a GaAs diode. Each is mounted in a 6-pin plastic dual in-line package. The series was designed specifically as a high-sensitivity type for operation in the 1.0 mA input region.

Glassolated™

High Current Transfer Ratio at Low Input Current

1500 V to 6000 V Minimum Isolation

Input-to-Output

$10^{11} \Omega$ Isolation Resistance

Low Coupling Capacitance—Typically 1.5 pF

Absolute Maximum Ratings

Maximum Temperature and Humidity

Storage Temperature -55°C to $+150^{\circ}\text{C}$

Operating Temperature -55°C to $+100^{\circ}\text{C}$

Pin Temperature (Soldering, 10 s) 260°C

Total Package Power Dissipation

at $T_A = 25^{\circ}\text{C}$

(LED plus Detector) 250 mW

Derate Linearly from 25°C 3.3 mW/ $^{\circ}\text{C}$

Input Diode

V_R Reverse Voltage 3.0 V

I_F Forward dc Current 80 mA

I_{pk} Peak Forward Current
(1 μs pulse width,
300 pps) 3.0 A

P_D Power Dissipation
at $T_A = 25^{\circ}\text{C}$ 150 mW

Derate Linearly from 25°C 2.0 mW/ $^{\circ}\text{C}$

Output Transistor (Darlington)

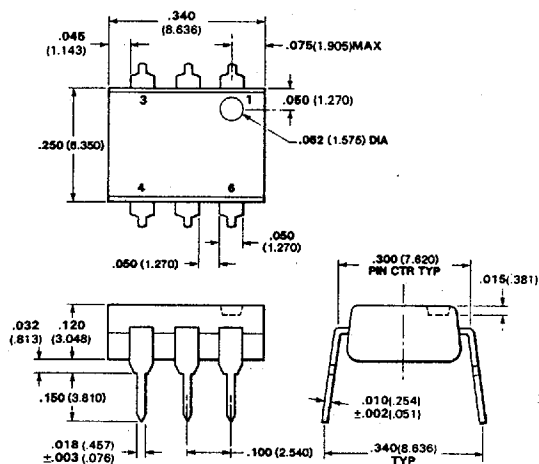
V_{CE} Collector-to-Emitter
Voltage 30 V

V_{CB} Collector-to-Base Voltage 30 V

V_{EC} Emitter-to-Collector
Voltage 7.0 V

P_D Power Dissipation
at $T_A = 25^{\circ}\text{C}$
($I_{C(max)}$ 100 mA
at $V_{CE} = 1.5 \text{ V}$) 150 mW
Derate Linearly from 25°C 2.0 mW/ $^{\circ}\text{C}$

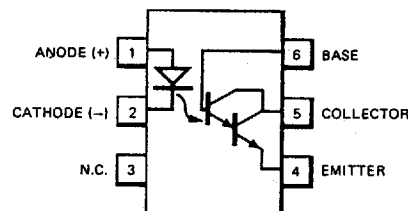
Package Outline



Notes

All dimensions in inches bold and millimeters (parentheses)
Tolerance unless specified = ± 0.015 ($\pm .381$)

Connection Diagram DIP (Top View)



Pin

1	Anode (+)	} Input Diode
2	Cathode (-)	
3	NC	
4	Emitter	} Output npn Phototransistor
5	Collector	
6	Base	

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Typical Electrical Characteristics

FCD860/C/D
FCD865/C/D

Electrical Characteristics—Input Diode $T_A = 25^\circ\text{C}$

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
V_F	Forward Voltage		1.25	1.5	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	$I_R = 10\text{ }\mu\text{A}$
C	Capacitance		150		pF	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$

Electrical Characteristics—Output Transistor $T_A = 25^\circ\text{C}$ (Darlington)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
V_{CEO}	Collector-to-Emitter Voltage	30			V	$I_C = 1.0\text{ mA}$, $I_F = 0$
V_{CBO}	Collector-to-Base Voltage	30			V	$I_C = 10\text{ }\mu\text{A}$, $I_F = 0$
V_{ECO}	Emitter-to-Collector Voltage	7.0			V	$I_E = 100\text{ }\mu\text{A}$, $I_F = 0$
V_{EBO}	Emitter-to-Base Voltage	6.0	8.0		V	$I_E = 100\text{ }\mu\text{A}$, $I_F = 0$
I_{CEO}	Collector-to-Emitter Leakage Current			100	nA	$V_{CE} = 10\text{ V}$, $I_F = 0$
h_{FE}	Forward Current Gain		20 k			$V_{CE} = 5.0\text{ V}$, $I_C = 25\text{ mA}$

Electrical Characteristics—Coupled $T_A = 25^\circ\text{C}$

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
V_{IO}	Input-to-Output Voltage (Note 1) FCD860, FCD865 FCD860C, FCD865C FCD860D, FCD865D	1500 5000 6000			V_{rms} V_{pk} V_{pk} V	
$V_{CE(sat)}$	Collector-to-Emitter Saturation Voltage			1.0	V	$I_C = 4.0\text{ mA}$, $I_F = 2.0\text{ mA}$
I_C	Collector Output Current FCD860, FCD860C	4.0			mA	$V_{CE} = 1.0\text{ V}$, $I_F = 2.0\text{ mA}$
	FCD865, FCD865C	2.0			mA	$V_{CE} = 1.0\text{ V}$, $I_F = 0.5\text{ mA}$
R_{IO}	Input-to-Output Resistance		10^{11}		Ω	$V_{IO} = 500\text{ V}$
C_{IO}	Input-to-Output Capacitance		1.5		pF	$V_{IO} = 0$, $f = 1.0\text{ MHz}$
t_r, t_f	Rise and Fall Times (Note 2)		80		μs	$I_C = 10\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\text{ }\Omega$

Notes

1. Isolation voltage defined as minimum of 5 s continuous application.
2. Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.